

1800114

https://www.phoenixcontact.com/us/products/1800114

Please be informed that the data shown in this PDF document is generated from our online catalog. Please find the complete data in the user documentation. Our general terms of use for downloads are valid.



Printed circuit board terminal, nominal current: 13.5 A, rated voltage (III/2): 400 V, nominal cross section: 1.5 mm², number of potentials: 2, number of rows: 1, number of positions per row: 2, product range: MKKDSNH 1,5, pitch: 5.08 mm, connection method: Screw connection with tension sleeve, screw head form: L Slotted, mounting: Wave soldering, conductor/PCB connection direction: 0 °, color: black, Pin layout: Linear pinning, Solder pin [P]: 3.5 mm, number of solder pins per potential: 1, type of packaging: packed in cardboard. The article can be aligned to create different nos. of positions!

## Your advantages

- · Well-known connection principle allows worldwide use
- · Low temperature rise, thanks to maximum contact force
- · Allows connection of two conductors
- Extremely small design for the respective conductor cross section
- · Tall type enables conductor connection for sealed PCBs
- The latching on the side enables various numbers of positions to be combined

#### Commercial data

Item number	1800114
Packing unit	50 pc
Minimum order quantity	50 pc
Note	Made to order (non-returnable)
Sales key	AA12
Product key	AALFJN
GTIN	4017918978518
Weight per piece (including packing)	2.77 g
Weight per piece (excluding packing)	2.37 g
Customs tariff number	85369010
Country of origin	CN



1800114

https://www.phoenixcontact.com/us/products/1800114

## Technical data

### Product properties

Product type	Printed circuit board terminal
Product family	MKKDSNH 1,5
Product line	COMBICON Terminals S
Туре	PC terminal block can be aligned
Number of positions	2
Pitch	5.08 mm
Number of connections	2
Number of rows	1
Number of potentials	2
Pin layout	Linear pinning
Solder pins per potential	1

### Electrical properties

#### Properties

Nominal current I <sub>N</sub>	13.5 A
Nominal voltage U <sub>N</sub>	400 V
Rated voltage (III/3)	250 V
Rated surge voltage (III/3)	4 kV
Rated voltage (III/2)	400 V
Rated surge voltage (III/2)	4 kV
Rated voltage (II/2)	630 V
Rated surge voltage (II/2)	4 kV

### Connection data

### Connection technology

Type	PC terminal block can be aligned
Nominal cross section	1.5 mm <sup>2</sup>
Conductor connection	
Connection method	Screw connection with tension sleeve
Conductor cross section rigid	0.14 mm² 1.5 mm²
0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	0.44 0.45 0.

Conductor cross section rigid	0.14 mm² 1.5 mm²
Conductor cross section flexible	0.14 mm² 1.5 mm²
Conductor cross section AWG	26 16
Conductor cross section flexible, with ferrule without plastic sleeve	0.25 mm² 1 mm²
Conductor cross section, flexible, with ferrule, with plastic sleeve	0.25 mm² 1.5 mm²
2 conductors with same cross section, solid	0.14 mm² 0.75 mm²
2 conductors with same cross section, flexible	0.14 mm² 0.75 mm²
2 conductors with same cross section, flexible, with ferrule without plastic sleeve	0.25 mm² 0.5 mm²



1800114

https://www.phoenixcontact.com/us/products/1800114

2 conductors with the same cross section, flexible, with TWIN ferrule with plastic sleeve	0.5 mm <sup>2</sup> 1 mm <sup>2</sup> (1st level: 0.5 mm <sup>2</sup> 1 mm <sup>2</sup> / 2nd level: 0. 5 mm <sup>2</sup> )
Stripping length	6 mm
Drive form screw head	Slotted (L)
Tightening torque	0.5 Nm 0.6 Nm

### Mounting

Mounting type	Wave soldering
Pin layout	Linear pinning

### Material specifications

#### Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface terminal point (top layer)	Tin (5 - 7 μm Sn)
Metal surface terminal point (middle layer)	Nickel (2 - 3 µm Ni)
Metal surface soldering area (top layer)	Tin (5 - 7 μm Sn)
Metal surface soldering area (middle layer)	Nickel (2 - 3 µm Ni)

#### Material data - housing

Color (Housing)	black (9005)
Insulating material	PA
Insulating material group	I
CTI according to IEC 60112	600
Flammability rating according to UL 94	V0
Glow wire flammability index GWFI according to EN 60695-2-12	850
Glow wire ignition temperature GWIT according to EN 60695-2-13	775
Temperature for the ball pressure test according to EN 60695-10-2	125 °C

#### **Dimensions**

Dimensional drawing	h h
Pitch	5.08 mm
Width [w]	10.16 mm
Height [h]	22.6 mm
Length [I]	8.6 mm
Installed height	19.1 mm
Solder pin length [P]	3.5 mm



1800114

https://www.phoenixcontact.com/us/products/1800114

Pin dimensions	0.5 x 1 mm
OCP design	
PCB design	40
Hole diameter	1.3 mm
echanical tests	
Test for conductor damage and slackening	
Specification	IEC 60998-2-1:2002-12
Result	Test passed
Pull-out test	
Specification	IEC 60998-2-1:2002-12
Conductor cross section/conductor type/tractive force	0.14 mm² / solid / > 10 N
setpoint/actual value	0.14 mm² / flexible / > 10 N
	1.5 mm² / solid / > 40 N
	1.5 mm² / flexible / > 40 N
Torque test	
Specification	IEC 60998-2-1:2002-12
Temperature-rise test	
Temperature-rise test	
Specification	IFC 00000 4:0000 40
Оробновного	IEC 60998-1:2002-12
Requirement temperature-rise test	Increase in temperature ≤ 45 K
Requirement temperature-rise test	
Requirement temperature-rise test  Insulation resistance	Increase in temperature ≤ 45 K
Requirement temperature-rise test  Insulation resistance  Specification  Insulation resistance, neighboring positions	Increase in temperature ≤ 45 K  IEC 60998-1:2002-12
Requirement temperature-rise test  Insulation resistance  Specification	Increase in temperature ≤ 45 K  IEC 60998-1:2002-12
Requirement temperature-rise test  Insulation resistance Specification Insulation resistance, neighboring positions  Air clearances and creepage distances	Increase in temperature ≤ 45 K  IEC 60998-1:2002-12  10 <sup>9</sup> Ω
Requirement temperature-rise test  Insulation resistance Specification Insulation resistance, neighboring positions  Air clearances and creepage distances   Specification	Increase in temperature ≤ 45 K  IEC 60998-1:2002-12  10 <sup>9</sup> Ω
Requirement temperature-rise test  Insulation resistance Specification Insulation resistance, neighboring positions  Air clearances and creepage distances   Specification Insulating material group	Increase in temperature ≤ 45 K  IEC 60998-1:2002-12  10 <sup>9</sup> Ω  IEC 60664-1:2007-04  I
Requirement temperature-rise test  Insulation resistance Specification Insulation resistance, neighboring positions  Air clearances and creepage distances   Specification Insulating material group Comparative tracking index (IEC 60112)	Increase in temperature ≤ 45 K  IEC 60998-1:2002-12  10 <sup>9</sup> Ω  IEC 60664-1:2007-04  I  CTI 600
Requirement temperature-rise test  Insulation resistance Specification Insulation resistance, neighboring positions  Air clearances and creepage distances   Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3)	Increase in temperature ≤ 45 K  IEC 60998-1:2002-12  10 <sup>9</sup> Ω  IEC 60664-1:2007-04  I  CTI 600  250 V
Requirement temperature-rise test  Insulation resistance Specification Insulation resistance, neighboring positions  Air clearances and creepage distances   Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3)	Increase in temperature ≤ 45 K  IEC 60998-1:2002-12  10 <sup>9</sup> Ω  IEC 60664-1:2007-04  I  CTI 600  250 V  4 kV
Requirement temperature-rise test  Insulation resistance Specification Insulation resistance, neighboring positions  Air clearances and creepage distances   Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3) minimum clearance value - non-homogenous field (III/3)	Increase in temperature ≤ 45 K  IEC 60998-1:2002-12  10 <sup>9</sup> Ω  IEC 60664-1:2007-04  I  CTI 600  250 V  4 kV  3 mm
Requirement temperature-rise test  Insulation resistance Specification Insulation resistance, neighboring positions  Air clearances and creepage distances   Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3) minimum clearance value - non-homogenous field (III/3) minimum creepage distance (III/3)	Increase in temperature ≤ 45 K  IEC 60998-1:2002-12  10 <sup>9</sup> Ω  IEC 60664-1:2007-04  I  CTI 600  250 V  4 kV  3 mm  3.2 mm
Requirement temperature-rise test  Insulation resistance Specification Insulation resistance, neighboring positions  Air clearances and creepage distances   Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3) minimum clearance value - non-homogenous field (III/3) minimum creepage distance (III/3) Note on connection cross section	Increase in temperature ≤ 45 K  IEC 60998-1:2002-12  10 <sup>9</sup> Ω  IEC 60664-1:2007-04  I  CTI 600  250 V  4 kV  3 mm  3.2 mm  With connected conductor 1.5 mm² (solid).
Requirement temperature-rise test  Insulation resistance Specification Insulation resistance, neighboring positions  Air clearances and creepage distances   Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3) minimum clearance value - non-homogenous field (III/3) minimum creepage distance (III/3) Note on connection cross section Rated insulation voltage (III/2)	Increase in temperature ≤ 45 K  IEC 60998-1:2002-12  10 <sup>9</sup> Ω  IEC 60664-1:2007-04  I  CTI 600  250 V  4 kV  3 mm  3.2 mm  With connected conductor 1.5 mm² (solid).  400 V
Requirement temperature-rise test  Insulation resistance Specification Insulation resistance, neighboring positions  Air clearances and creepage distances   Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3) minimum clearance value - non-homogenous field (III/3) minimum creepage distance (III/3) Note on connection cross section Rated insulation voltage (III/2) Rated surge voltage (III/2)	Increase in temperature ≤ 45 K  IEC 60998-1:2002-12  10 <sup>9</sup> Ω  IEC 60664-1:2007-04  I  CTI 600  250 V  4 kV  3 mm  3.2 mm  With connected conductor 1.5 mm² (solid).  400 V  4 kV
Requirement temperature-rise test  Insulation resistance Specification Insulation resistance, neighboring positions  Air clearances and creepage distances   Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3) minimum clearance value - non-homogenous field (III/3) Note on connection cross section Rated insulation voltage (III/2) Rated surge voltage (III/2) minimum clearance value - non-homogenous field (III/2)	Increase in temperature ≤ 45 K  IEC 60998-1:2002-12  10 <sup>9</sup> Ω  IEC 60664-1:2007-04  I  CTI 600  250 V  4 kV  3 mm  3.2 mm  With connected conductor 1.5 mm² (solid).  400 V  4 kV  3 mm
Requirement temperature-rise test  Insulation resistance Specification Insulation resistance, neighboring positions  Air clearances and creepage distances   Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3) minimum clearance value - non-homogenous field (III/3) minimum creepage distance (III/3) Note on connection cross section Rated insulation voltage (III/2) Rated surge voltage (III/2) minimum clearance value - non-homogenous field (III/2) minimum creepage distance (III/2)	Increase in temperature ≤ 45 K  IEC 60998-1:2002-12  10 <sup>9</sup> Ω  IEC 60664-1:2007-04  I  CTI 600  250 V  4 kV  3 mm  3.2 mm  With connected conductor 1.5 mm² (solid).  400 V  4 kV  3 mm  3 mm  3 mm



1800114

https://www.phoenixcontact.com/us/products/1800114

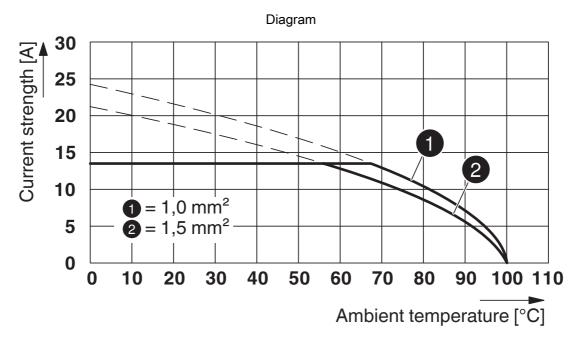
minimum creepage distance (II/2)	3.2 mm
Environmental and real-life conditions	
Vibration test	
Specification	IEC 60068-2-6:1995-03
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz 60.1 Hz)
Acceleration	5g (60.1 Hz 150 Hz)
Test duration per axis	2.5 h
Test directions	X-, Y- and Z-axis
Glow-wire test	
	IEC 60998-1:2002-12
Specification	
Temperature	850 °C
Time of exposure	5 s
Ambient conditions	
Ambient temperature (operation)	-40 °C 100 °C (Depending on the current carrying capacity/derating curve)
Ambient temperature (storage/transport)	-40 °C 70 °C
Relative humidity (storage/transport)	30 % 70 %
Ambient temperature (assembly)	-5 °C 100 °C
Packaging specifications	
Type of packaging	packed in cardboard



1800114

https://www.phoenixcontact.com/us/products/1800114

## **Drawings**



Type: MKKDSNH 1,5/...-5,08

Tested according to DIN EN 60512-5-2:2003-01

Reduction factor = 1 Number of positions: 5



1800114

https://www.phoenixcontact.com/us/products/1800114

## **Approvals**

To download certificates, visit the product detail page: https://www.phoenixcontact.com/us/products/1800114

	CULus Recognized Approval ID: E60425-19770427				
	Nominal voltage U <sub>N</sub>	Nominal current I <sub>N</sub>	Cross section AWG	Cross section mm <sup>2</sup>	
Use group B					
Screw connection	300 V	10 A	30 - 14	-	
2 conductors with the same cross-section	300 V	10 A	- 18	-	
Use group D					
Screw connection	300 V	10 A	30 - 14	-	
2 conductors with the same cross-section	300 V	10 A	- 18	-	



1800114

https://www.phoenixcontact.com/us/products/1800114

## Classifications

UNSPSC 21.0

### **ECLASS**

	ECLASS-13.0	27460101			
	ECLASS-15.0	27460101			
ETIM					
	ETIM 9.0	EC002643			
UN	ISPSC				

39121400



1800114

https://www.phoenixcontact.com/us/products/1800114

## Environmental product compliance

#### EU RoHS

Fulfills EU RoHS substance requirements	Yes, No exemptions		
China RoHS			
Environment friendly use period (EFUP)	EFUP-E		
	No hazardous substances above the limits		
EU REACH SVHC			
REACH candidate substance (CAS No.)	No substance above 0.1 wt%		

Phoenix Contact 2025 @ - all rights reserved https://www.phoenixcontact.com

Phoenix Contact USA 586 Fulling Mill Road Middletown, PA 17057, United States (+717) 944-1300 info@phoenixcon.com